

Appl. No. 09/754,264
Amendment/Response in reply
to the Notice of Non-
Compliant Amendment dated
April 27, 2004

RECEIVED
CENTRAL FAX CENTER

MAY 14 2004

OFFICIAL

Page 1 of 9

**IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE**

Appl. No.: 09/754,264

Applicant(s): Tetsuo Usami, et al.

Filed: January 5, 2001

Title: Deposition Method For Wiring Thin Film

TC/A.U.: 2800/2814

Examiner: S. H. Rao

Atty. Docket: OKI.202

**CERTIFICATE OF MAILING OR
TRANSMISSION § 1.8**

I certify that this correspondence is
being:

☐ deposited with the U.S.
Postal Service with sufficient
postage as first-class mail in an
envelope addressed to:

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

☒ transmitted by facsimile to
Technology Center 2800 of the
U.S. Patent and Trademark Office
at 703-872-9306.

On: 14 May 2004

By: *Michelle Welgoss*
Michelle Welgoss

AMENDMENT and/or RESPONSE UNDER 37 C.F.R. § 1.111

Honorable Assistant Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Notice of Non-Compliant Amendment dated April 27, 2004,
kindly reconsider the application in view of the following amendments and remarks.

Appl. No. 09/754,264
Amendment/Response in reply
to the Notice of Non-
Compliant Amendment dated
April 27, 2004

Page 2 of 9

1. Amendments to the claims reflected in the complete listing of the claims, which begins on page 3 of this paper; and
2. Remarks/Discussion of issues, which begin on page 7 of this paper.